

## 3A, 20V - 40V Schottky Barrier Surface Mount Rectifier

### FEATURES

- AEC-Q101 qualified
- Low power loss, high efficiency
- Ideal for automated placement
- Guard ring for overvoltage protection
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

### APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- Converter

### MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.210g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
$I_F$	3	A
$V_{RRM}$	20 - 40	V
$I_{FSM}$	100	A
$T_{J\ MAX}$	125	°C
Package	DO-214AB (SMC)	
Configuration	Single die	



DO-214AB (SMC)



ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)					
PARAMETER	SYMBOL	SSL32H	SSL33H	SSL34H	UNIT
Marking code on the device		SL32	SL33	SL34	
Repetitive peak reverse voltage	$V_{RRM}$	20	30	40	V
Reverse voltage, total rms value	$V_{R(RMS)}$	14	21	28	V
Forward current	$I_F$	3			A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	$I_{FSM}$	100			A
Junction temperature	$T_J$	- 55 to +125			°C
Storage temperature	$T_{STG}$	- 55 to +150			°C

<b>THERMAL PERFORMANCE</b>			
<b>PARAMETER</b>	<b>SYMBOL</b>	<b>TYP</b>	<b>UNIT</b>
Junction-to-lead thermal resistance	$R_{\theta JL}$	13	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	53	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	15	°C/W

**Thermal Performance Note:** Units mounted on PCB (16mm x 16mm Cu pad test board)

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^\circ\text{C}$ unless otherwise noted)					
<b>PARAMETER</b>	<b>CONDITIONS</b>	<b>SYMBOL</b>	<b>TYP</b>	<b>MAX</b>	<b>UNIT</b>
Forward voltage <sup>(1)</sup>	$I_F = 3\text{A}, T_J = 25^\circ\text{C}$	$V_F$	-	0.41	V
Reverse current @ rated $V_R$ <sup>(2)</sup>	$T_J = 25^\circ\text{C}$	$I_R$	-	200	$\mu\text{A}$
			-	500	$\mu\text{A}$
	$T_J = 100^\circ\text{C}$		-	50	mA
			-	100	mA

**Notes:**

1. Pulse test with  $PW = 0.3\text{ms}$
2. Pulse test with  $PW = 30\text{ms}$

<b>ORDERING INFORMATION</b>		
<b>ORDERING CODE<sup>(1)</sup></b>	<b>PACKAGE</b>	<b>PACKING</b>
SSL3xH	DO-214AB (SMC)	3,000 / Tape & Reel

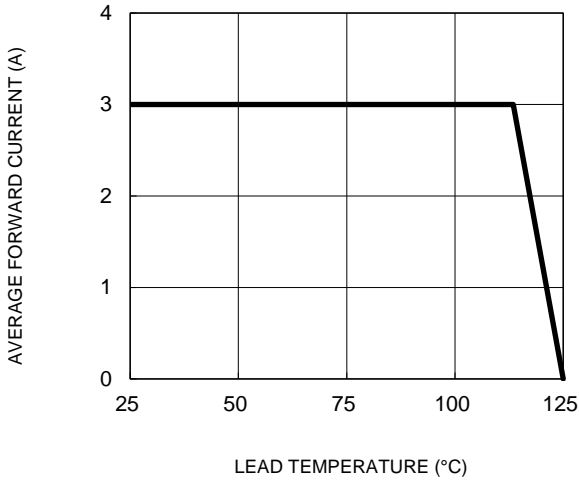
**Notes:**

1. "x" defines voltage from 20V(SSL32H) to 40V(SSL34H)

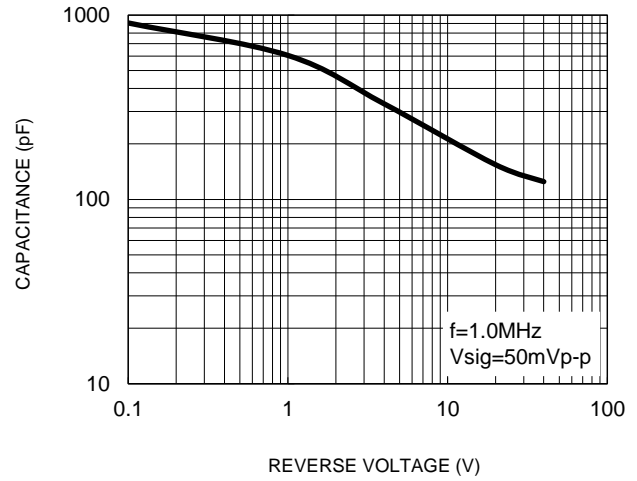
**CHARACTERISTICS CURVES**

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

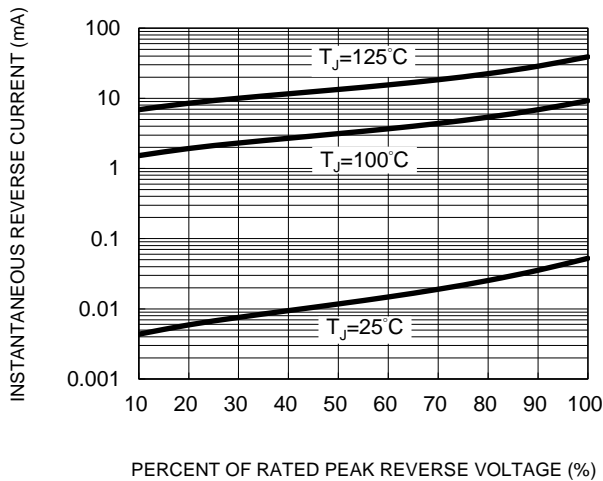
**Fig.1 Forward Current Derating Curve**



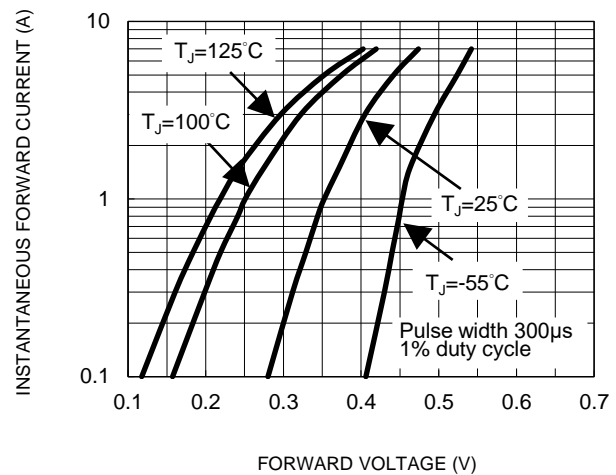
**Fig.2 Typical Junction Capacitance**



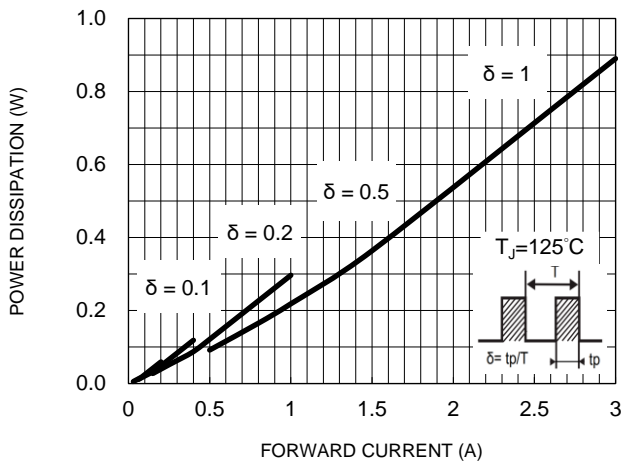
**Fig.3 Typical Reverse Characteristics**



**Fig.4 Typical Forward Characteristics**



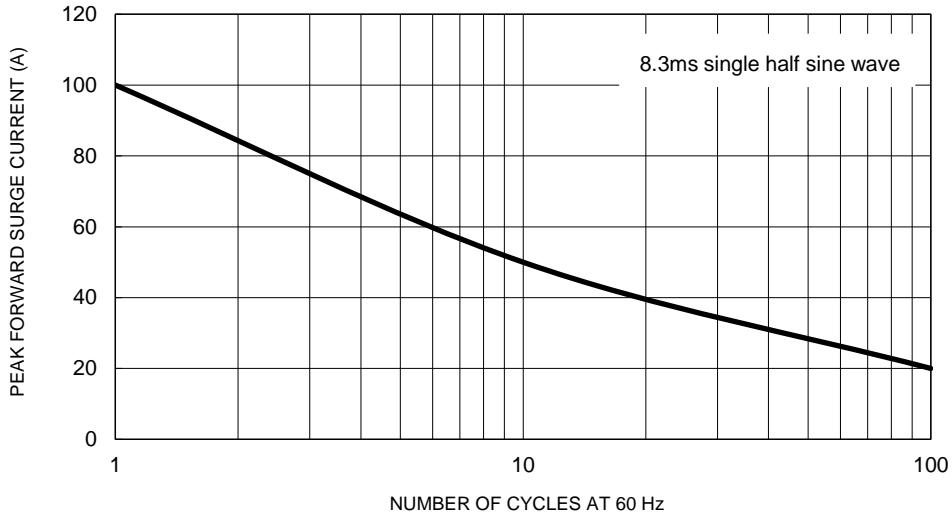
**Fig.5 Typical Forward Power Dissipation vs. Forward Current**



**CHARACTERISTICS CURVES**

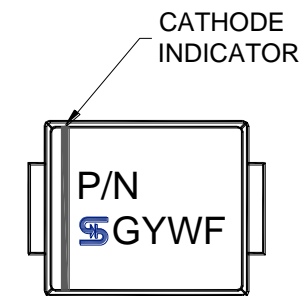
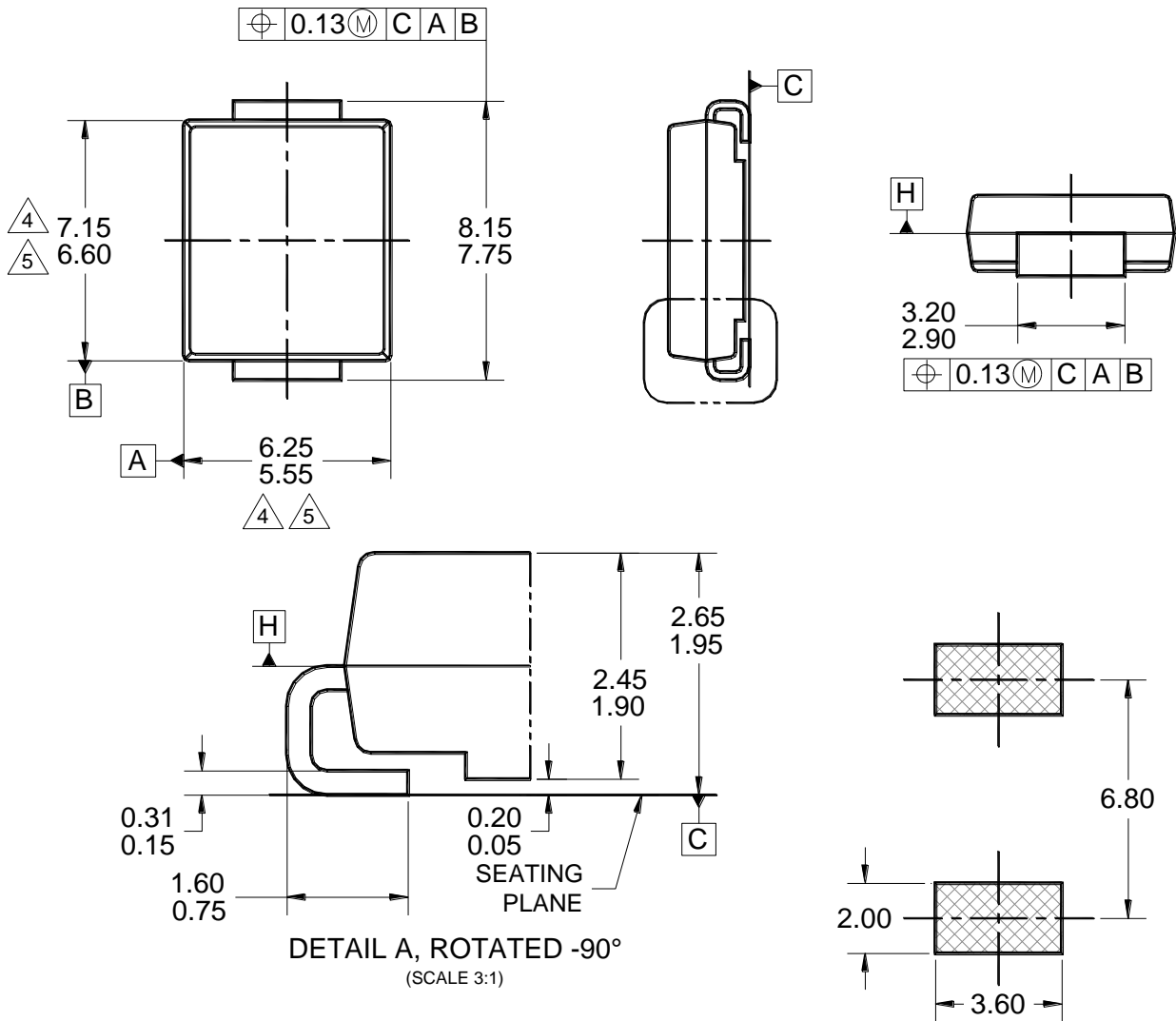
(T<sub>A</sub> = 25°C unless otherwise noted)

**Fig.6 Maximum Non-Repetitive Forward Surge Current**



**PACKAGE OUTLINE DIMENSIONS**

**DO-214AB (SMC)**



**MARKING DIAGRAM**

P/N = MARKING CODE  
G = GREEN COMPOUND  
YW = DATE CODE  
F = FACTORY CODE

**SUGGESTED PAD LAYOUT**

**NOTES: UNLESS OTHERWISE SPECIFIED**

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
3. PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AB, ISSUE D.
4. MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
5. MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
6. DWG NO. REF: HQ2SD07-DO214SMC-036 REV A.

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